

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
CHING-TIEN CHEN	07/28/2014
SHU-LIN DUAN	07/28/2014
WEI WAN	07/28/2014
PING-CHUAN CHU	07/28/2014
XIAO-JUAN QI	07/28/2014
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<b>City:</b>	NEW TAIPEI CITY
<b>State/Country:</b>	TAIWAN
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	29497669
<b>CORRESPONDENCE DATA</b>	
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<b>ATTORNEY DOCKET NUMBER:</b>	TAI-162-A-DESIGN
<b>NAME OF SUBMITTER:</b>	ARNOLD S. WEINTRAUB
<b>SIGNATURE:</b>	/Arnold S. Weintraub/
<b>DATE SIGNED:</b>	07/28/2014
<b>Total Attachments: 2</b>	
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PATENT



UNITED STATES PATENT RIGHTS, OR  
UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS

Attorney Docket No.  
TAI-162-A-DESIGN

ASSIGNMENT

Application No. 29/497,669 Filed July 28, 2014

\*\*\* (Given Name FAMILY NAME (ALL CAPS)) \*\*\*

Insert Name(s) of Inventor(s) ⇒ WHEREAS, Ching-Tien CHEN, Shu-Lin DUAN, Wei WAN, Ping-Chuan CHU and Xiao-Juan QI  
(hereinafter designated as the undersigned) has (have) invented certain new and useful improvements  
in:

Insert Title of Invention ⇒ ELECTRICAL CONNECTOR TERMINAL

for which an application for Letters Patent of the United States of America has been executed by the  
undersigned (except in the case of a provisional application)

Insert Date of Signing of Appin. ⇒ On July 28, 2014; and

Insert Name of Assignee ⇒ WHEREAS, Advanced-Connectek Inc.

Insert Address of Assignee ⇒ of 1st Fl., No. 2, Alley 9, Lane 45, Pao-Hsin Rd., Xindian Dist., New Taipei City, Taiwan, R.O.C.

its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is  
desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters  
Patent(s) that may be granted therefor in the United States of America and

Check Box if Appropriate ⇒ ☐ in any foreign countries.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged,  
the undersigned has (have) sold, assigned and transferred, and by these presents does sell, assign and  
transfer unto said Assignee the full and exclusive right to the said invention in the United States of  
America, its territories, dependencies and possessions and the entire right, title and interest in and to  
any and all Letters Patent(s) which may be granted therefor in the United States of America, its  
territories, dependencies and possessions, and if the box above is designated, in any and all foreign  
countries; and to any and all divisions, reissues, continuations, conversions and extensions thereof for  
the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any  
continuing, divisional, conversion or reissue applications thereof and also to execute separate  
assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letters Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patent(s) resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of The Weintraub Group, P.L.C. the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date	July 28, 2014	Name of Inventor	<u>Ching-Tien CHEN</u> (Signature) Ching-Tien CHEN
Date	July 28, 2014	Name of Inventor	<u>Shu-Lin DUAN</u> (Signature) Shu-Lin DUAN
Date	July 28, 2014	Name of Inventor	<u>Wei WAN</u> (Signature) Wei WAN
Date	July 28, 2014	Name of Inventor	<u>Ping-Chuan CHU</u> (Signature) Ping-Chuan CHU
Date	July 28, 2014	Name of Inventor	<u>Xiao-Juan QI</u> (Signature) Xiao-Juan QI
Date		Name of Inventor	<u></u> (Signature)